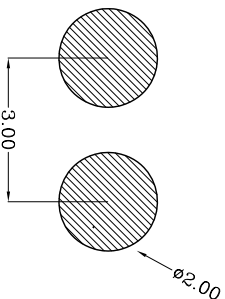
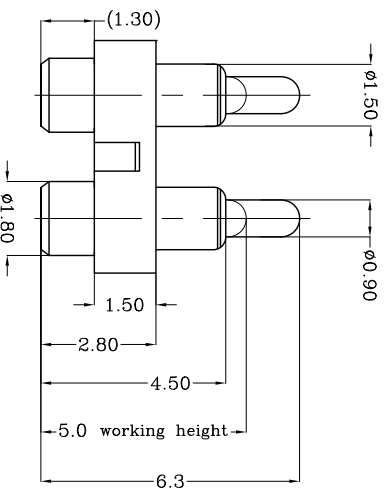
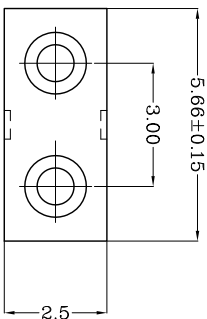
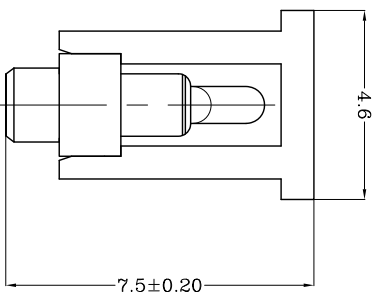
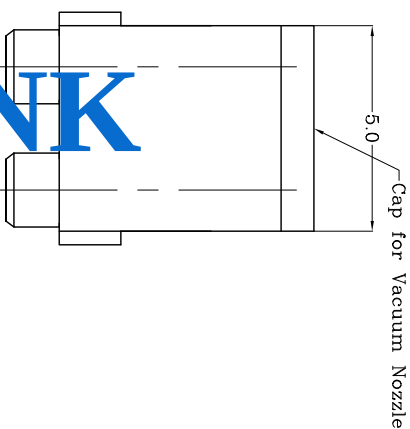
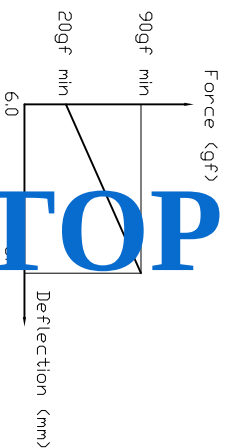


DWG NO.
C-100160



Recommended solder paste thickness is 0.10 mm
Recommended PCB Layout



USED ON

1

Notes:
1 Material, Housing: PA 4.6 (30% Glass Filled)

Color Black.

Contact: Brass

2 Mechanical demands:

Plating Plunger: Min 0.4um Au over 1.4um Ni

Plating Body: Min 0.10um Au over 1.4um Ni.

LDC		NAME		BATTERY POGO CONNECTOR 2 POSITIONS	
-		SURF. TEXTURE: 32/		PGC-1.5-6.3-R-2P-3.0PH	
	Update Remark	REMOVE BURRS, BREAK SHARP EDGES R0.05 MAX			
	APVD	DO NOT SCALE PRINT			
	REVISION	SCALE			
	RECORD	A4			
	DATE	DWG NO. C-100160			
		SHEET 1 OF 1		REV C	

DIMENSIONS IN MM TOLERANCES UNLESS OTHER SPECIFIED	MATL	HT TR	FIN
0 = ±		—	
0.0 = ±0.15		APVD	
0.00 = ±0.10		Qin	
0.000 = ±		REL	
0.000 = ±		CHK	
	<i>Top-Link Electronics</i>		Top-Link Electronics Ltd.

100160-2
PART NUMBER